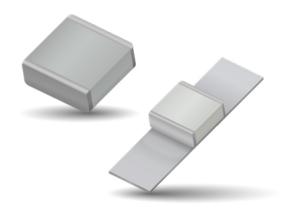
RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

800C Series NP0 Porcelain, High RF Power Ultra-Low ESR





GENERAL DESCRIPTION

KYOCERA AVX's 800 C Series offers superb performance in demanding high RF power applications requiring consistent and reliable operation. The combination of highly conductive metal electrode systems, optimized case geometries, and proprietary dielectrics, yields the lowest ESR. KYOCERA AVX's new NPO low loss rugged dielectrics are designed to provide superior heat transfer in high RF power applications. Ultralow ESR and superior thermal performance ensure that the 800C Series products are your best choice for high RF power applications from VHF through microwave frequencies.

TYPICAL APPLICATIONS

Bypass

- DC Blocking
- Coupling
- Impedance Matching

Tuning

TYPICAL CIRCUIT APPLICATIONS

- HF/RF Power Amplifiers
- Plasma Chambers

Transmitters

- · Medical (MRI coils)
- · Antenna Tuning

ENVIRONMENTAL TEST

Thermal Shock	MIL-STD-202, Method 107, Condition A.
Moisture Resistance	MIL-STD-202, Method 106.
Low Voltage Humidity	MIL-STD-202, Method 103, Condition A, with 1.5 Volts DC applied while subjected to an environment of 85°C with 85% relative humidity for 240 hours min.
Life Test	MIL-STD-202, Method 108, for 2000 hours, at 125°C. Voltage applied. 200% of WVDC for capacitors rated at 500 volts DC or less. 120% of WVDC for capacitors rated at 1250 volts DC or less. 100% of WVDC for capacitors rated above 1250 volts DC.

FEATURES

- High Q
- Low ESR/ESL
- High RF Power
- 3600 WVDC
- · Capacitance Range: 2.2 pF to 3000 pF
- Case C Size (.250" x .250") Ultra-Stable Performance
 - High RF Current/Voltage
 - · High Reliability
 - · RoHS Compliant, Pb free

PACKAGING OPTIONS





Tape & Reel

Trav (180 pcs)



ENVIRONMENTAL CHARACTERISTICS

Quality Factor (Q)	Greater than 5,000 (2.2 pF to 1000 pF) @ 1 MHz. Greater than 5,000 (1100 pF to 3000 pF) @ 1 KHz.				
Temperature Coefficient of Capacitance (TCC)	0 ±30 PPM/°C (-55°C to +125°C)				
Insulation Resistance (IR)	2.2 pF to 3000 pF: 10 ⁵ Megohms min. @ +25°C at rated WVDC. 10 ⁴ Megohms min. @ +125°C at rated WVDC. Max. test voltage is 500 VDC.				
Working Voltage (WVDC)	See Capacitance Values Table				
Dielectric Withstanding Voltage (DWV)	250% of WVDC for capacitors rated at 500 volts DC or less for 5 seconds. 150% of WVDC for capacitors rated above 500 volts DC and ≤1250 volts DC for 5 seconds. 120% of WVDC for capacitors rated above 1250 volts DC for 5 seconds.				
Retrace	Less than ±(0.02% or 0.02 pF), whichever is greater.				
Aging Effects	None				
Piezoelectric Effects	None				
Capacitance Drift	±(0.02% or 0.02 pF), whichever is greater.				
Operating Temperature Range	From -55°C to +125°C (No derating of working voltage).				
Termination Styles	See Mechanical Configurations				
Terminal Strength	Terminations for chips withstand a pull of 10 lbs. min., 20 lbs. typical, for 5 seconds in direction perpendicular to the termination surface of the capacitor. Test per MIL-STD-202, method 211.				

RF/Microwave Capacitors

RF/Microwave Multilayer Capacitors (MLC)

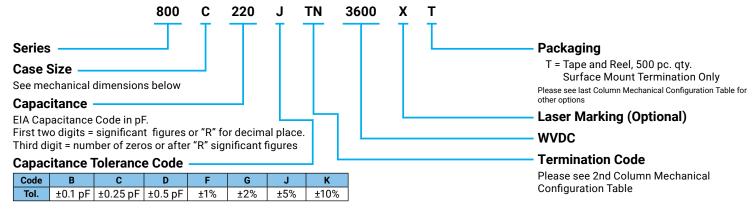
800C Series NP0 Porcelain, High RF Power Ultra-Low ESR



CAPACITANCE VALUES

CAP CODE	CAP (pF)	TOL.	RATED WVDC	CAP CODE	CAP (pF)	TOL.	RATED WVDC	CAP CODE	CAP (pF)	TOL.	RATED WVDC																				
2R2	2.2			240 24		241	240																								
2R4	2.4]		270	27			271	270																						
2R7	2.7			300	30			301	300																						
3R0	3.0			330	33			331	330																						
3R3	3.3]		360	36]	3600	361	360																						
3R6	3.6			390	39			391	390																						
3R9	3.9			430	43			431	430																						
4R3	4.3	B C D		470	47			471	470		1000																				
4R7	4.7	B, C, D		510	51			511	510																						
5R1	5.1			560	56			561	560																						
5R6	5.6			620	62			621	620																						
6R2	6.2									680 68	681	680																			
6R8	6.8																						3600	750	75	F, G, J, K		751	750	F, G, J, K	
7R5	7.5																				820	82			821	820					
8R2	8.2																				910	91			911	910					
9R1	9.1								101	100			102	1000																	
100	10			111	110		2500	112	1100																						
110	11			121	120		2300	122	1200																						
120	12			131	130			152	1500		600																				
130	13	F, G, J. K			151	150			182	1800																					
150	15			161	160			222	2200																						
160	16			181	180			242	2400																						
180	18			201	200			272	2700																						
200	20			221	220			302	3000		500																				
220	22																														

HOW TO ORDER



The above part number refers to a 800 C Series (case size C) 22 pF capacitor, J tolerance (±5%),3600 WVDC, with TN termination (RoHS Compliant, Tin Plated over Non-Magnetic Barrier Termination), laser marking and T&R packaging

RF/Microwave Capacitors RF/Microwave Multilayer Capacitors (MLC) 800C Series NP0 Porcelain, High RF Power Ultra-Low ESR



MECHANICAL CONFIGURATIONS

Series	Term.	Case Size	Outlines W/T Is A	Body Dimensions Inches (mm)			Lead And Termination Dimensions And Materials				
& Case Size	Code	& Type	Termination Surface	Length Width Th	Thickness (T)	Overlap (Y)	Materials	Pkg Type	Pkg Code		
800C	Т	C Solderable Barrier	Y→ ←	230+.025010 (5.84+0.64-0.25)			RoHS Compliant Tin Plated over Nickel Barrier Termination	T&R, 250 or 500 pcs Tray, 36 or 180 pcs	T250 or T J36 or J180		
800C	MS	C			245 ±.025		.200 (5.08) max.	.040 (1.02) max.	$\begin{array}{l} \mbox{High Purity Silver Leads} \\ \mbox{$L_{L} = .500 (12.7)$ min.} \\ \mbox{$W_{L} = .240 \pm .005 (6.10$} \\ \mbox{$\pm .127)$} \\ \mbox{$T_{L} = .004 \pm .001 (.102$} \\ \mbox{$\pm .025)$} \\ \mbox{Leads are Attached with} \\ \mbox{High Temperature} \\ \mbox{Solder} \end{array}$	Tray, 24 or 60 pcs	J24 or J60
800C	AR	C Axial Ribbon	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$					Silver Leads L _L = .500 (12.7) min. W _L = ** See below T _L = .004 ±.001 (.102 ±.025)	Box, 24 pcs	B24	

Custom lead styles and lengths are available; consult factory. All leads are high purity silver attached with high temperature solder and are RoHS compliant. ** W_L = .110 (2.79) for capacitance values \leq 680 pF; W_L = .130 (3.30) for capacitance values > 680 pF

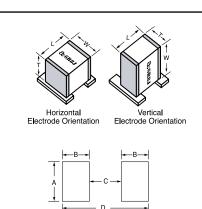
NON-MAGNETIC MECHANICAL CONFIGURATIONS

Series	Term.	Case Size	Outlines W/T is a	Body Dimensions Inches (mm)			Lead and Termination Dimensions and Materials			
& Case SIZE	Code	& Type	Termination Surface	Length (L)	Width (W)	Thickness (T)	Overlap (Y)	Materials	Pkg Type	Pkg Code
800C	TN	C Non-Mag Solderable Barrier.	$\begin{array}{c c} Y \rightarrow & \longleftarrow & \longleftarrow & \longleftarrow \\ \hline & W & & \longleftarrow \\ \rightarrow & \bot & \longleftarrow & \uparrow & \rightarrow & \top & \longleftarrow \\ \end{array}$	230+.025010 (5.84+0.64-0.25)		015 .200 (5.08)		RoHS Compliant Tin Plated over Non-Magnetic Barrier Termination	T&R, 250 or 500 pcs Tray, 36 or 180 pcs	T250 or T J36 or J180
800C	MN	C Non-Mag Microstrip245		±.025 (6.22 ±0.64)	50 ±.015 (6.35 ±0.38)		.040 (1.02) max.	1.02) T _L = .004 ±.001 (.102 + 025)	Tray, 24 or 60 pcs	J24 or J60
800C	AN	C Non-Mag Axial Ribbon	$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	245 ±.025 (6.22 ±0.64)				Silver Leads L _L = .500 (12.7) min. W _L = ** See below T _L = .004 ±.001 (.102 ±.025)	Tray, 24 or 60 pcs	J24 or J60

RF/Microwave Capacitors RF/Microwave Multilayer Capacitors (MLC) 800C Series NP0 Porcelain, High RF Power Ultra-Low ESR



SUGGESTED MOUNTING PAD DIMENSIONS

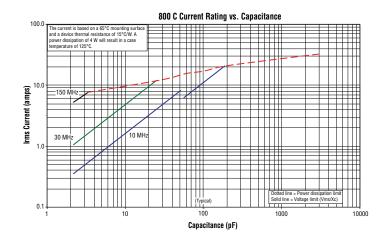


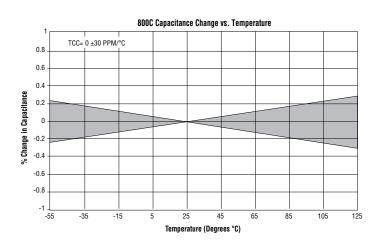
Case C Vertical Mount									
Cap Value	Cap Value Pad Size A Min. B Min. C Min. D Min.								
All Values	Normal	.200	.050	.200	.300				
	High Density	.180	.030	.200	.260				

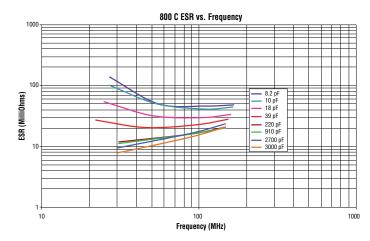
Case C Horizontal Mount									
Cap Value Pad Size A Min. B Min. C Min. D Min.									
All Values	Normal	.280	.050	.200	.300				
	High Density	.260	.030	.200	.260				

Dimensions are in inches.

PERFORMANCE DATA







单击下面可查看定价,库存,交付和生命周期等信息

>>AVX